

## Features

- ◇ 30W (8/20 $\mu$ s) Peak Pulse Power
- ◇ Low Capacitance ESD Protection
- ◇ SOD-882 Package
- ◇ RoHS Compliant
- ◇ Matte Tin Lead finish (Pb-Free)
- ◇ Protect One High Speed Data Line
- ◇ Meet IEC61000-4-2 Level 4:  
     Contact Discharge > 8kV  
     Air Discharge > 15kV

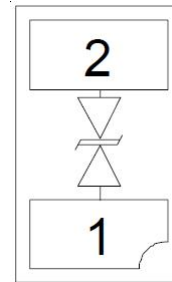
## Applications

- ◇ Communication System
- ◇ Portable Instrumentation
- ◇ Audio and Video Equipment
- ◇ Computers and Peripherals
- ◇ USB 1.1, USB 2.0 Ports

## Circuit Diagram



## PIN Diagram



## Ordering information

Device	Package	Reel Size	Qty / Reel
AU0511P1	SOD-882	7 inch	10000

## Maximum Ratings (Ta = 25°C)

Symbol	Parameter	Value	Unit
PPK	Peak Pulse Power	30	W
IPP	Peak Pulse Current	2	A
VESD (Contact)	Contact ESD Voltage per IEC61000-4-2	8	kV
VESD (Air)	Air ESD Voltage per IEC61000-4-2	15	kV
TJ	Junction Temperature	-55 to +150	°C
TSTG	Storage Temperature	-55 to +150	°C

**Electrical Characteristics (Ta = 25°C)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
VRWM	Reverse Working Peak Voltage				5	V
VBR	Reverse Breakdown Voltage	IT = 1mA	5.5		9.5	V
IR	Reverse Leakage Current	VRWM = 5V			0.1	μA
VC	Clamping Voltage	IPP = 1A (8/20μs)			12	V
VC	Clamping Voltage	IPP = 2A (8/20μs)			15	V
CJ	Capacitance	VR = 0V, f = 1MHz			0.5	pF

**Typical Performance Curves**

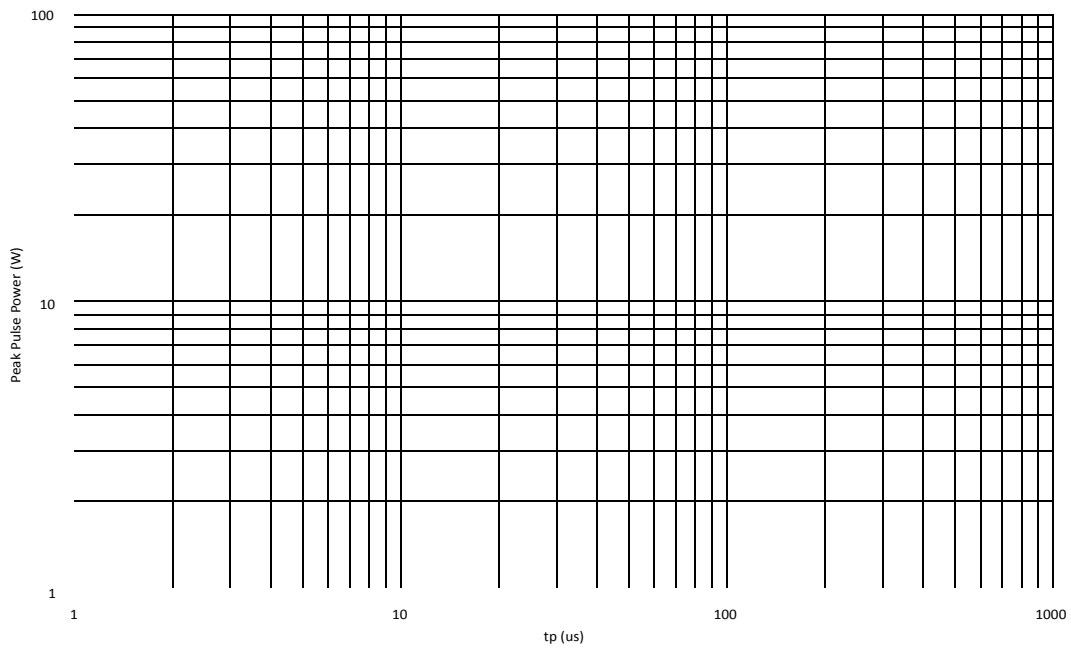


Figure 1. Peak Pulse Power Derating

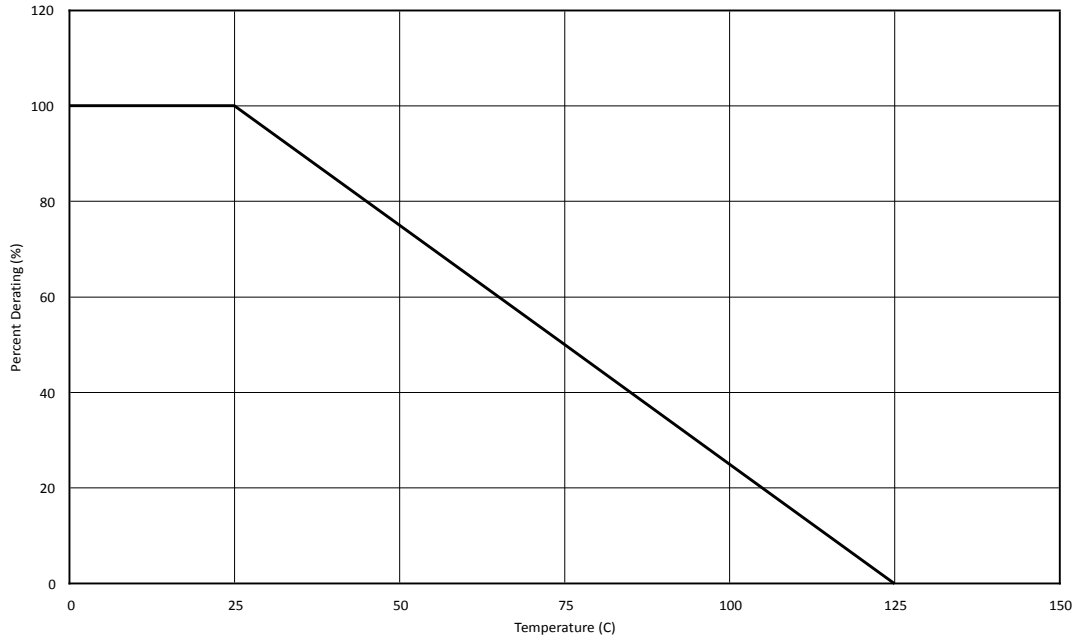


Figure 2. Peak Pulse Power Derating vs Temperature

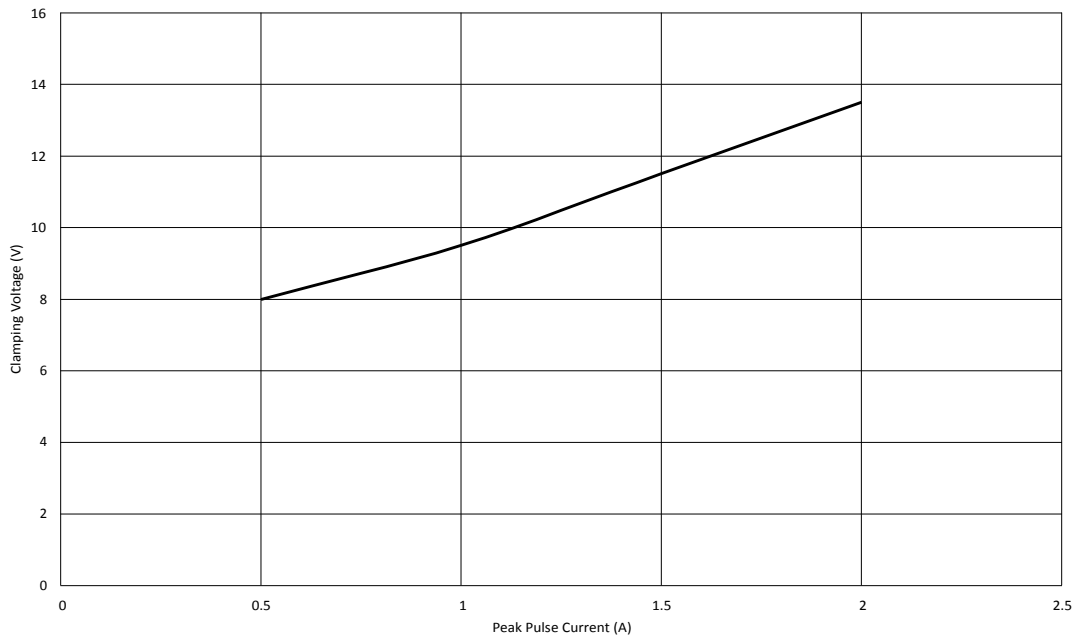


Figure 3. Peak Pulse Current vs Clamping Voltage

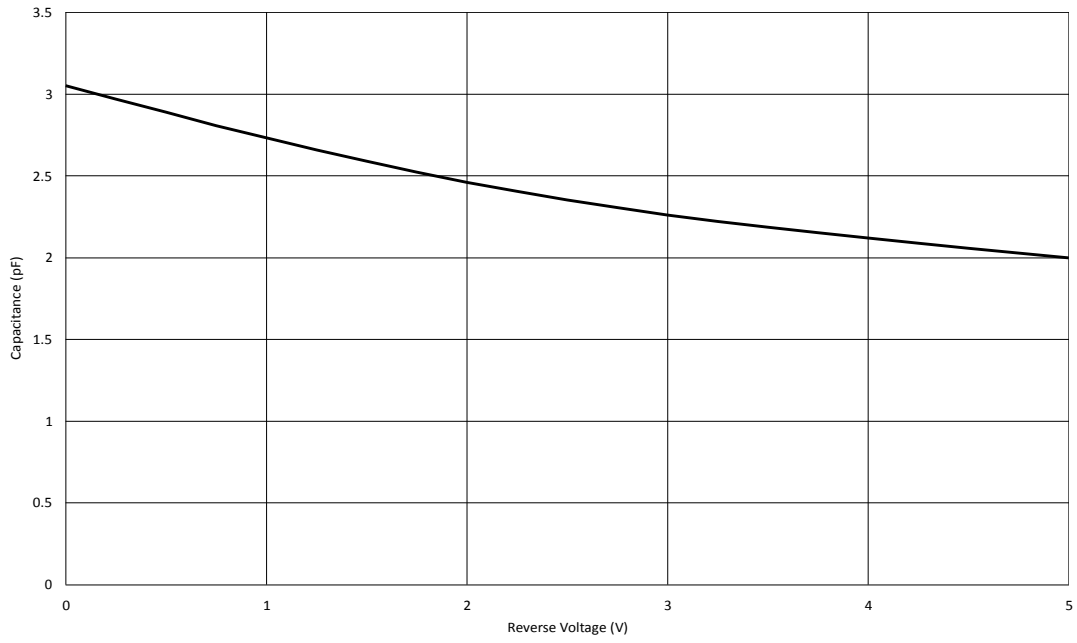
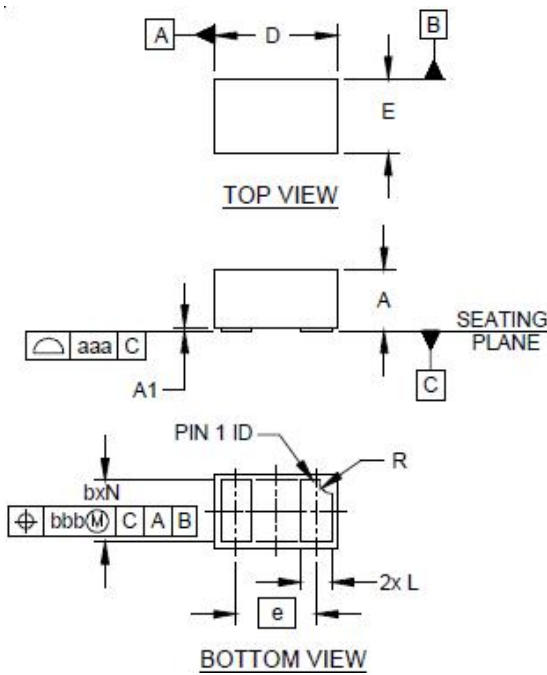


Figure 4. Reverse Voltage vs Capacitance

SOD-882 Dimension



DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.016	.020	.022	0.40	0.50	0.55
A1	.000	.001	.002	0.00	0.03	0.05
b	.018	.020	.022	0.45	0.50	0.55
D	.035	.039	.043	0.90	1.00	1.10
E	.020	.024	.028	0.50	0.60	0.70
e	.026 BSC			0.65 BSC		
L	.008	.010	.012	0.20	0.25	0.30
R	.002	.004	.006	0.05	0.10	0.15
N	2			2		
aaa	.003			0.08		
bbb	.004			0.10		